APPLICA	BLE STAN	DARD									
	Operating temperature range		-55 °C to 85 °C	C	Storage temperature range Operating or storage humidity range			-10°C TO 50°C(Packed condition)			
RATING	Voltage		30V AC / DC				Re	Relative humidity 90 % MAX (Not dew			
	Current		▲ 0.3 A	Applicabl	Applicable cable		t=0.3±0.03mm, Gold plating				
	1		SPEC	IFICA	TION	S					
TI	EM		TEST METHOD				REQU	IREMENTS	QT	AT	
	UCTION	I			I					1	
General exa		Visually a	and by measuring instrumen	nt.	A	ccording to c	Irawing	l.	×	×	
			rmed visually.			(note 1)			×	×	
ELECTR	ICAL CHA	RACTE	RISTICS							4	
/oltage proc			for 1 min.		N	lo flashover o	or brea	kdown.	×	—	
nsulation re	sistance	100 V D0	<u>).</u>		5	50 MΩ MIN.			×	—	
Contact resis	stance	AC 20 m	VMAX 1mA		1					!	
	Starice	AC 20 III	AC 20 mV MAX , 1 mA .			100 mΩ MAX.			×	_	
					Ir	Including FPC	bulk r	esistance (L=8mm)		<u> </u>	
	NICAL CHA			lo	9	No electric		optionuity of 1		1	
			equency 10 to 55 Hz, half amplitude 75 mm, for 10 cycles in 3 axial directions.			 No electrical discontinuity of 1 μs. Contact resistance: 100 mΩ MAX. 			×		
		981 m/s ²	981 m/s ² , duration of pulse 6 ms			 3 No damage, crack and looseness of parts. 			×	1 - 1	
Maakari			s in 3 both axial directions.				• .	400 0 1111	×	<u> </u>	
Mechanical operation		10 time	10 times insertions and extractions.				(1) Contact resistance: $100 \text{ m}\Omega$ MAX.				
FPC insertion force Measur		Measure	easured by applicable FPC			② No damage, crack and looseness of parts. Insertion force : Direction of insertion			×	<u> </u>	
			ess of FPC shall be t=0.30mm			2.6+0.14 × n N MAX (<i>note 2</i>)					
			condition.)		(r	(n: Number of contacts)					
FPC retentio	on force		ed by applicable FPC			Retention force : Direction of extraction			×	—	
		`	ss of FPC shall be t=0.30mn condition.)	n		+0.07 × n N I n: Number of		,			
					(1	I. NUMBER OF	contac	(5)		<u> </u>	
Corrosion sa		-	at 35±2 °C, 5 % salt water	r sprav	(1) Contact re	sistanc	e: 100 mΩ MAX.	×		
		for 96 h.		i Spidy	Ċ						
Rapid change of		Temperature -55→+15 _{TO} +35→+85→+15 _{TO} +35°C			5°C (1	 Contact resistance: 100 mΩ MAX. Insulation resistance: 50 MΩ MIN. 				—	
temperature		Time $30 \rightarrow 2 \text{ to } 3 \rightarrow 30 \rightarrow 2 \text{ to } 3 \text{ min}$			0						
Damp heat		Under			(3	No damage	e, crac	k and looseness of parts.			
Damp heat (steady state)		Exposed at 40±2 °C, Relative humidity 90 to 95 %, 96 h.							×	_	
Damp heat,c			Exposed at -10 to +65 °c,) Contact re	sistanc	e: 100 mΩ MAX.	×	_	
Relative			ative humidity 90 to 96 %, cycles, TOTAL 240 h.			2 Insulation resistance: 1 M Ω MIN.					
						(At high humidity)					
						 ③ Insulation resistance: 50 MΩ MIN. (At dry) ④ No damage, crack and looseness of parts 					
								-	_	<u> </u>	
I											
COUN	IT DE	SCRIPTI	ON OF REVISIONS		DESIGN	NED		CHECKED		TE	
3	DIS-		IS-F-00010250		SE. YOKOYAMA			HY. YAMAZAKI	2021	0713	
REMARK						APPR		NF. MIYAZAKI	2017	0823	
						CHEC		YN. TAKASHITA	2017	0823	
						DESIC	GNED	HH. MURAKAMI	2017	0823	
Unless otherwise specified, re			efer to IEC 60512.			DRAWN		HH. MURAKAMI		0823	
Note QT:Q	ualification Te	st AT:As	surance Test X:Applicable T	Fest	DRA	WING NO.		ELC-368163-9	9-00)	
HRS	SI	SPECIFICATION SHEET			PART N	ART NO. FH62-**S-0. 25SH		2− * *S−0. 25SHW (9	9)		
	HIR	OSF FI	ECTRIC CO., LTD.		CODE N	10	o. CL580		\mathbf{V}	1/2	
						NU.	0L080			., _	

	SPECIFICAT	IONS		
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
Dry heat	Exposed at 85±2°C, 96 h.	 Contact resistance: 100 mΩ MAX. 	×	_
Cold	Exposed at -55±3℃, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42]	Exposed at 40±2 °C, Relative humidity 80±5% 25±5 ppm for 96 h.	① Contact resistance: 100 mΩ MAX.	×	-
Hydrogen sulphide [JIS C 60068-2-43]	Exposed at 40±2 ℃, Relative humidity 80±5% , 10 to 15 ppm for 96 h.		×	-
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	-
Resistance to soldering heat	 1) Reflow soldering : Peak TMP. 250 °C MAX . Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow : 2 times 2) Soldering irons : TMP. 350±10 °C for 5±1 sec . 	No deformation of case of excessive looseness of the terminals. (<i>note 4</i>)	×	_

(note 1)

This product features top-contact point.

"One Action Lock" completes FPC lock just by inserting the FPC.

Do not operate the locking-lever when inserting the FPC.

(note 2)

Do not insert the FPC to this product at an angle.

(note 3)

There's a case which FPC retention force doesn't fulfill the value, because FPC specification affects the result of FPC retention force.

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC.

(note 4)

Blisters which may be generated on the housing do not affect product performance.

Note QT:C	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC-368163-99-00			
HRS	SPECIFICATION SHEET	PART NO.	FH62-**S-0. 25SHW(99)				
	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580		2/2	